

C0603X439D2TACAUTO

SMD Auto X8G HT150C Flex, Ceramic, 4.3 pF, +/-0.5 pF, 200 VDC, X8G, SMD, MLCC, High Temperature, Ultra-Stable, Automotive Grade, 0603,



General Information			
Series	SMD Auto X8G HT150C Flex		
Style	SMD Chip		
Description	SMD, MLCC, High Temperature, Ultra-Stable, Automotive Grade		
Features	High Temperature, Ultra-Stable, Automotive Grade		
RoHS	Yes		
Termination	Flexible Termination		
Marking	No		
Qualifications	AEC-Q200		
AEC-Q200	Yes		
Typical Component Weight	4.6 mg		
Shelf Life	78 Weeks		
MSL	1		

Dimensions	
Chip Size	0603
L	1.6mm +/-0.17mm
W	0.8mm +/-0.15mm
Т	0.8mm +/-0.15mm
S	0.4mm MIN
В	0.45mm +/-0.15mm

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Т	0.8mm +/-0.15mm		
S	0.4mm MIN		
В	0.45mm +/-0.15mm		
Packaging Specifications			

4000

T&R, 180mm, Paper Tape

Packaging

Packaging Quantity

Specifications		
Capacitance	4.3 pF	
Measurement Condition	1 MHz 1.0Vrms	
Tolerance	+/-0.5 pF	
Voltage DC	200 VDC	
Dielectric Withstanding Voltage	500 VDC	
Temperature Range	-55/+150°C	
Temp. Coefficient	X8G	
Capacitance Change with Reference to +25°C and 0 VDC Applied (TCC)	30 ppm/C, 1MegaHz 1.0Vrms	
Dissipation Factor	0.1% 1 MHz 1.0Vrms	
Aging Rate	0% Loss/Decade Hour: Referee Time is 1000 Hours	
Insulation Resistance	100 GOhms	

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